

Product Summary

$V_{(BR)DSS}$	$R_{DS(ON) Max}$	I_D $T_A = +25^\circ C$ (Notes 4 & 6)
-60V	85m Ω @ $V_{GS} = -10V$	-3.9A
	125m Ω @ $V_{GS} = -4.5V$	-3.2A

Description

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

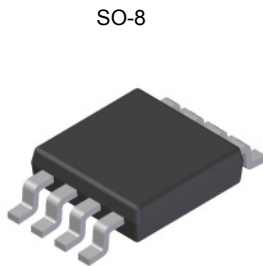
- DC-DC Converters
- Power Management Functions
- Disconnect Switches
- Motor Control

Features

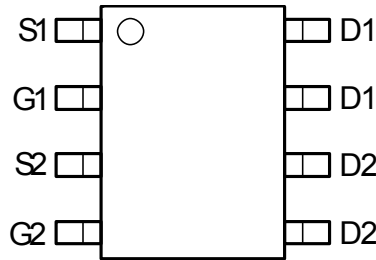
- Low On-Resistance
- Fast Switching Speed
- Low Threshold
- Low Gate Drive
- Low Profile SOIC Package
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Available**

Mechanical Data

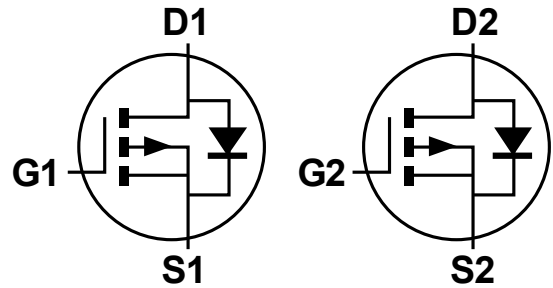
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish; Solderable per MIL-STD-202, Method 208 e3
- Weight: 0.074 grams (approximate)



Top View



Top View



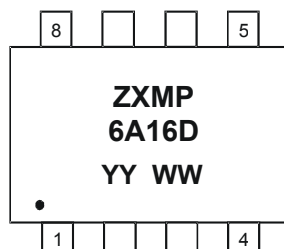
Equivalent Circuit

Ordering Information

Part Number	Qualification	Case	Packaging
ZXMP6A16DN8QTA	Automotive	SO-8	500/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_grade_definitions/.
 5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



ZXMP6A16D = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Year (ex: 11 = 2011)
 WW = Week (01 - 53)

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

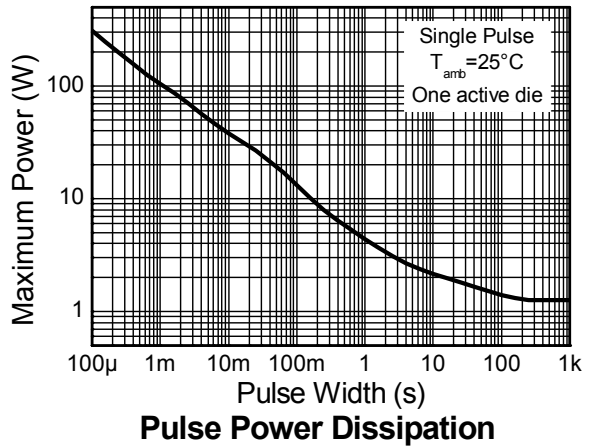
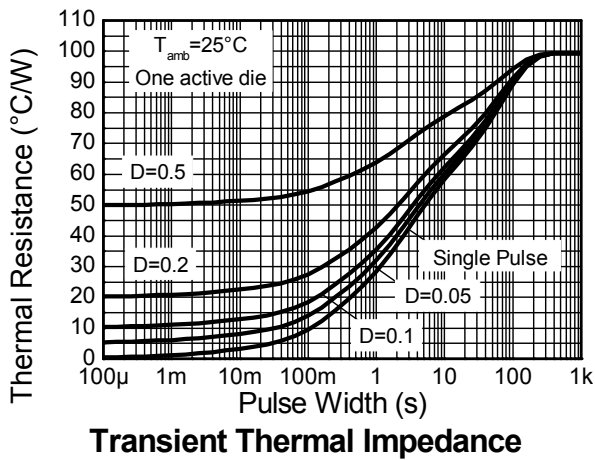
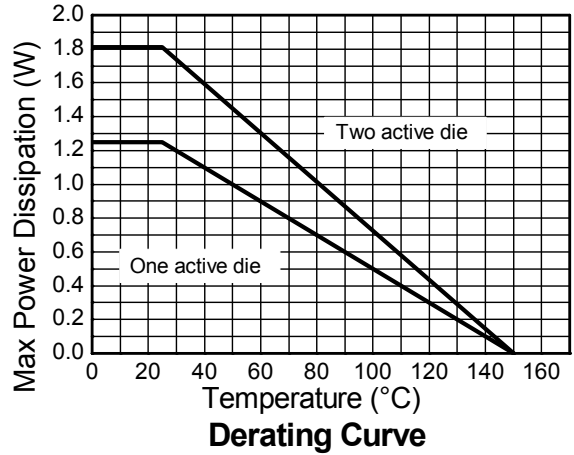
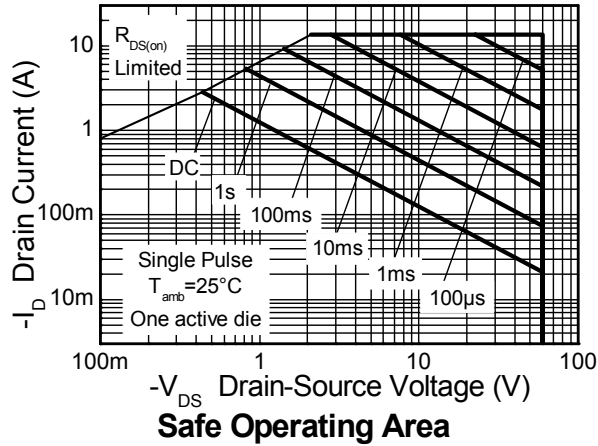
Characteristic		Symbol	Value	Unit	
Drain-Source voltage		V_{DSS}	-60	V	
Gate-Source voltage		V_{GS}	± 20	V	
Continuous Drain current	$V_{GS} = 10\text{V}$	I_D	(Notes 8 & 10)	-3.9	A
			$T_A = +70^\circ\text{C}$ (Notes 8 & 10)	-3.1	
			(Notes 7 & 10)	-2.9	
Pulsed Drain current		I_{DM}	-18.3	A	
Continuous Source current (Body diode)		I_S	-3.2	A	
Pulsed Source current (Body diode)		I_{SM}	-18.3	A	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Power dissipation Linear derating factor	(Notes 7 & 10)	P_D	1.25	W mW/ $^\circ\text{C}$
			10.0	
	(Notes 7 & 11)		1.81	
			14.5	
Thermal Resistance, Junction to Ambient	(Notes 7 & 10)	$R_{\theta JA}$	2.15	$^\circ\text{C/W}$
	(Notes 7 & 11)		17	
	(Notes 8 & 10)		100	
Thermal Resistance, Junction to Lead	(Notes 7 & 11)	$R_{\theta JL}$	70	$^\circ\text{C/W}$
	(Notes 8 & 10)		60	
Operating and storage temperature range		T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

- Notes:
6. AEC-Q101 V_{GS} maximum is $\pm 16\text{V}$.
 7. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 8. Same as note (7), except the device is measured at $t \leq 10$ sec.
 9. Same as note (7), except the device is pulsed with $D = 0.02$ and pulse width 300 μs .
 10. For a dual device with one active die.
 11. For a device with two active die running at equal power.
 12. Thermal resistance from junction to solder-point.

Thermal Characteristics

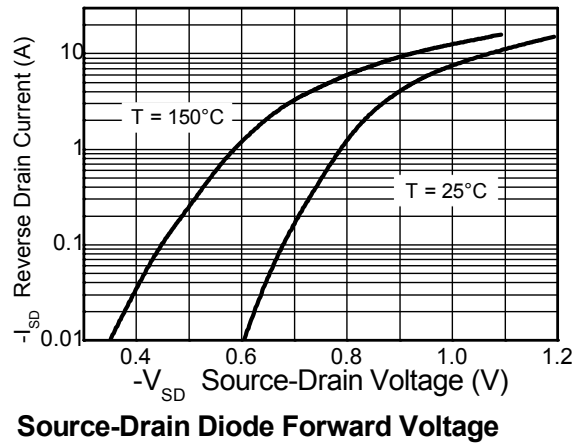
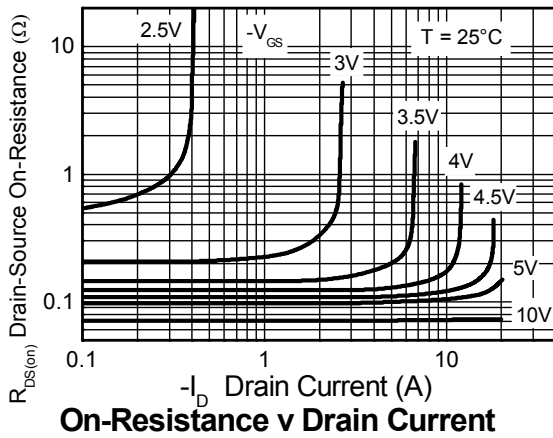
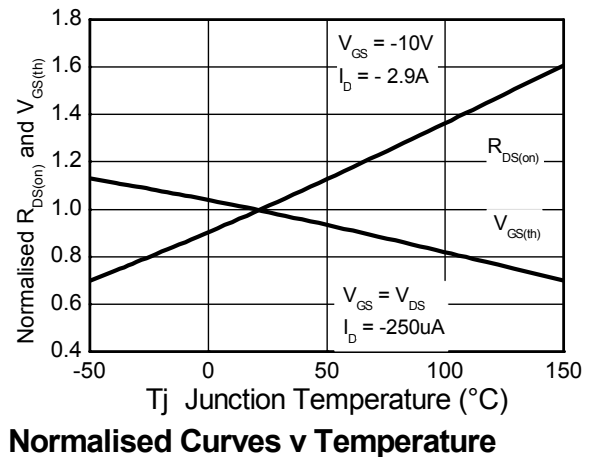
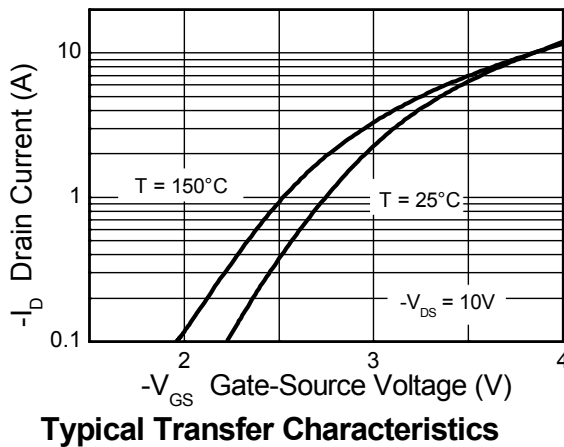
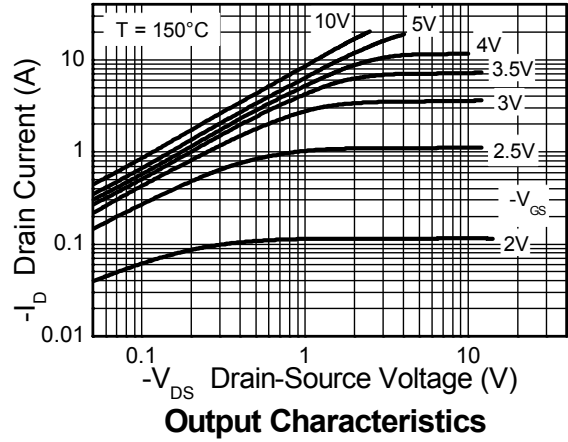
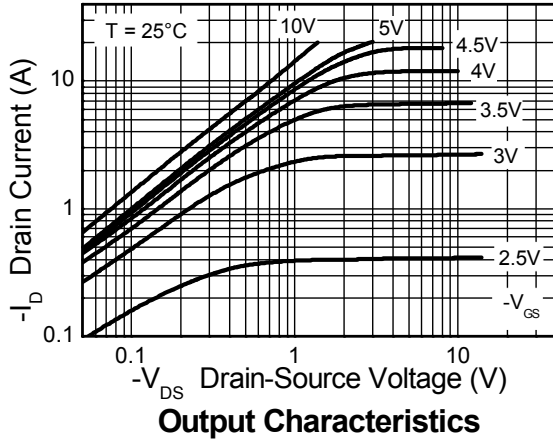


Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

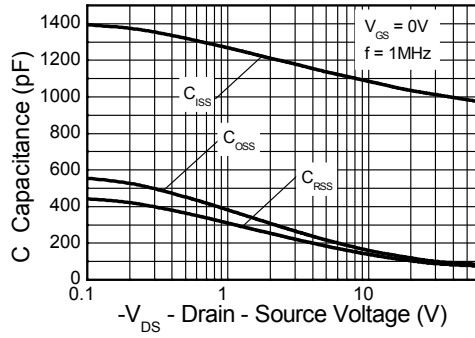
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	-60	—	—	V	I _D = -250μA, V _{GS} = 0V	
Zero Gate Voltage Drain Current	I _{DSS}	—	—	-1.0	μA	V _{DS} = -60V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	V _{GS} = ±20V, V _{DS} = 0V	
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(th)}	-1	—	—	V	I _D = -250μA, V _{DS} = V _{GS}	
Static Drain-Source On-Resistance (Note 13)	R _{DS(on)}	—	—	85	mΩ	V _{GS} = -10V, I _D = -2.9A	
			—	125		V _{GS} = -4.5V, I _D = -2.4A	
Forward Transconductance (Notes 13 & 14)	g _{fs}	—	7.2	—	S	V _{DS} = -15V, I _D = -2.9A	
Diode Forward Voltage (Note 13)	V _{SD}	—	-0.85	-0.95	V	I _S = -3.4A, V _{GS} = 0V, T _J = +25°C	
Reverse recovery time (Note 14)	t _{rr}	—	29.2	—	ns	I _S = -2A, di/dt = 100A/μs,	
Reverse recovery charge (Note 14)	Q _{rr}	—	39.6	—	nC	T _J = +25°C	
DYNAMIC CHARACTERISTICS (Note 14)							
Input Capacitance	C _{iss}	—	1021	—	pF	V _{DS} = -30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	C _{oss}	—	83.1	—	pF		
Reverse Transfer Capacitance	C _{rss}	—	56.4	—	pF		
Total Gate Charge (Note 15)	Q _g	—	12.1	—	nC	V _{GS} = -5V	V _{DS} = -30V, I _D = -2.9A
Total Gate Charge (Note 15)	Q _g	—	24.2	—	nC	V _{GS} = -10V	
Gate-Source Charge (Note 15)	Q _{gs}	—	2.5	—	nC		
Gate-Drain Charge (Note 15)	Q _{gd}	—	3.7	—	nC		
Turn-On Delay Time (Note 15)	t _{D(on)}	—	3.5	—	ns	V _{DD} = -30V, V _{GS} = -10V, I _D = -1A, R _G = 6Ω	
Turn-On Rise Time (Note 15)	t _r	—	4.1	—	ns		
Turn-Off Delay Time (Note 15)	t _{D(off)}	—	35	—	ns		
Turn-Off Fall Time (Note 15)	t _f	—	10	—	ns		

- Notes:
13. Measured under pulsed conditions. Pulse width ≤ 300μs; duty cycle ≤ 2%
 14. For design aid only, not subject to production testing.
 15. Switching characteristics are independent of operating junction temperatures.

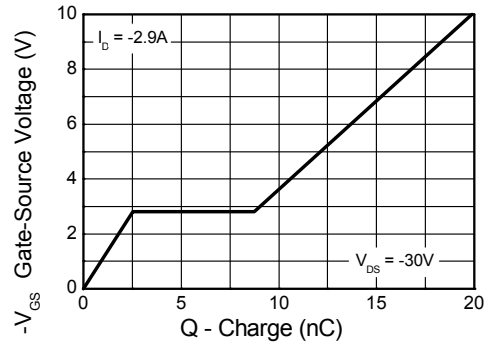
Typical Characteristics



Typical Characteristics (cont.)

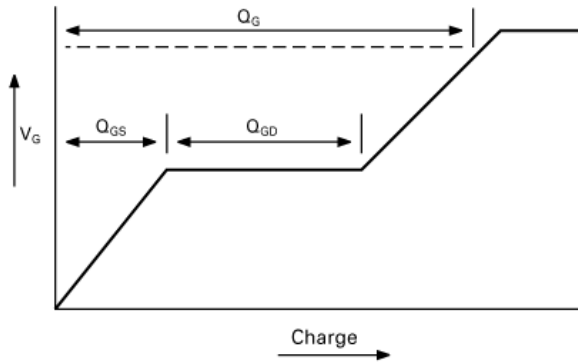


Capacitance v Drain-Source Voltage

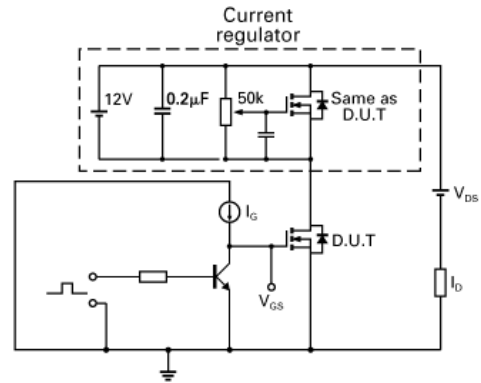


Gate-Source Voltage v Gate Charge

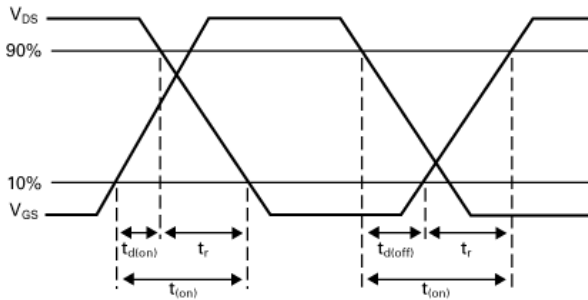
Test Circuits



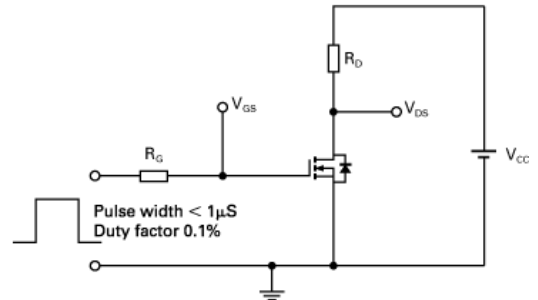
Basic gate charge waveform



Gate charge test circuit



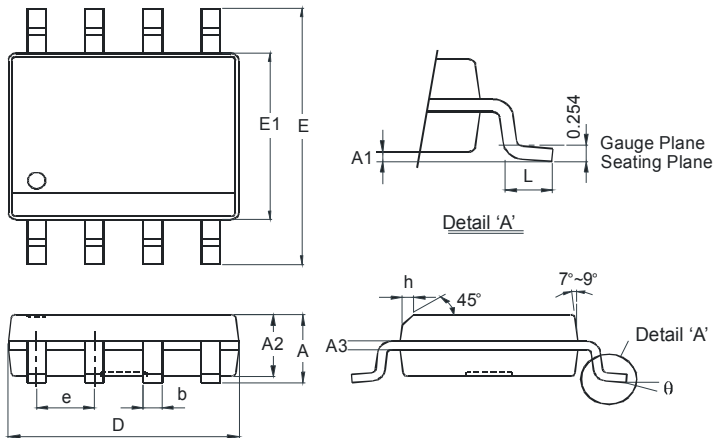
Switching time waveforms



Switching time test circuit

Package Outline Dimensions

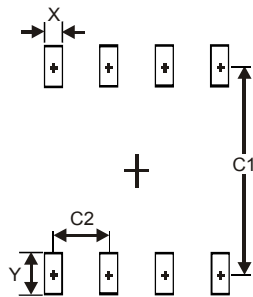
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SO-8		
Dim	Min	Max
A	-	1.75
A1	0.10	0.20
A2	1.30	1.50
A3	0.15	0.25
b	0.3	0.5
D	4.85	4.95
E	5.90	6.10
E1	3.85	3.95
e	1.27 Typ	
h	-	0.35
L	0.62	0.82
θ	0°	8°
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
X	0.60
Y	1.55
C1	5.4
C2	1.27

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